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<b>TRANSMITTAL FORM</b> (to be used for all correspondence after initial filing)	Application Number	08/824,633	
	Filing Date	March 27, 1997	
	First Named Inventor	Charles F. Drill, et al.	
	Group Art Unit	3723	
	Examiner Name	M. Rachuba	
Total Number of Pages in This Submission	7	Attorney Docket Number	PHA 51265B

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Charles F. Drill, et al.  
Appl. No. : 08/824,633  
Filed : March 27, 1997  
Title : A Customized Polishing Pad For  
Selective Process Performance  
During Chemical Mechanical  
Polishing  
Docket No. : PHA 51265B

Grp./Art Unit : 3723  
Examiner: M. Rachuba

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## RESPONSE TO OFFICE ACTION OF 25 SEPTEMBER 2002

Sir:

## REMARKS

This is in response to the Office Action of September 25, 2002. Claims 22-35 are pending and Claims 22-35 have been rejected.

Arguments are presented herein to overcome the rejections set forth in the presently outstanding Office Action of September 25, 2002.

No new matter has been added.

In view of the remarks below, Applicant respectfully requests reconsideration and further examination.

About The Invention

The present invention relates generally to the field of chemical mechanical polishing, and more particularly to polishing pads that have two or more polishing regions with each polishing region having distinct polishing characteristics which are different from those of the other polishing region(s). These polishing regions, which have different, and distinct, polishing characteristics, are arranged such that a workpiece to be polished, e.g., a wafer, can be selectively frictionally engaged with a particular one of those regions. For example, consistent with the present invention, the